# **Diode** Fast



# RoHS Compliant



#### Features:

- · Glass passivated chip junction
- · High efficiency, low V<sub>F</sub>
- · High current capability
- · High reliability
- · High surge current capability
- For use in low voltage, high frequency inventor, free wheeling, and polarity protection application

### **Specifications:**

#### **Mechanical Data:**

Cases : Moulded plastic

Lead : Pure tin plated, lead free, solderable per MIL-STD-202, Method 208 guaranteed

Polarity : Colour band denotes cathode end

High temperature soldering guaranteed : 260°C/10 seconds/0.375", (9.5mm) lead lengths at 5lbs., (2.3kg) tension

Mounting position : Any
Weight : 1.65g

## **Maximum Ratings and Electrical Characteristics:**

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Type Number	Symbol	HER603G	HER606G	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	200	600	
Maximum RMS Voltage	V <sub>RMS</sub>	140	420	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	200	600	
Maximum Average Forward Rectified Current 0.375" (9.5mm) Lead Length at T <sub>A</sub> = 55°C	I <sub>(AV)</sub>	6		A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	150		
Maximum Instantaneous Forward Voltage at 3A	V <sub>F</sub>	1	1.7	V





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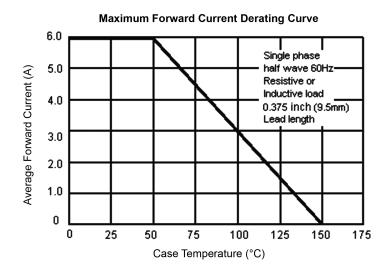
Type Number	Symbol	HER603G	HER606G	Units
Maximum DC Reverse Current at $T_A = 25^{\circ}$ C at Rated DC Blocking Voltage at $T_A = 125^{\circ}$ C	I <sub>R</sub>	10 200		μ <b>Α</b> μ <b>Α</b>
Maximum Reverse Recovery Time (Note 1)	T <sub>rr</sub>	50	75	nS
Typical Junction Capacitance (Note 2)	C <sub>j</sub>	80	65	pF
Typical Thermal Resistance (Note 3)	$R_{ heta JA}$	37		°C/W
Operating Temperature Range	TJ	-65 to +150		°C
Storage Temperature Range	T <sub>STG</sub>			

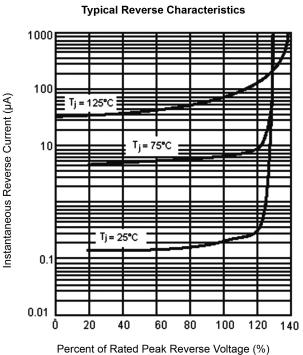
**Note: 1**. Reverse Recovery Test Conditions:  $I_F = 0.5A$ ,  $I_R = 1A$ ,  $I_{RR} = 0.25A$ .

Note: 2. Measured at 1MHz and Applied Reverse Voltage of 4V DC.

Note: 3. Mount on Cu-Pad Size 16mm x 16mm on PCB.

### Ratings and Characteristic Curves (HER305G, HER306G)



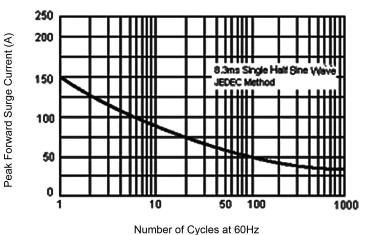


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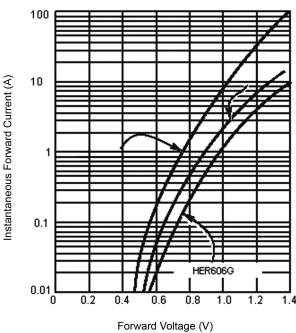




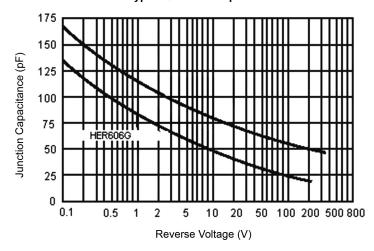
#### **Maximum Non-Repetitive Forward Surge Current**



#### Typical Instantaneous Forward Characteristics



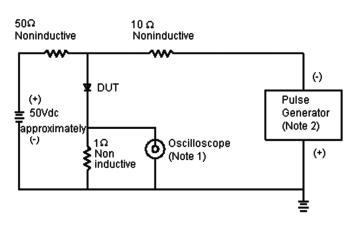
#### **Typical Junction Capacitance**

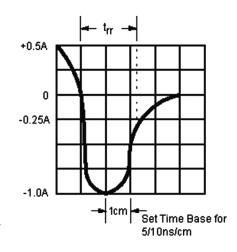


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#### Reverse Recovery Time Characteristic and Test Circuit Diagram

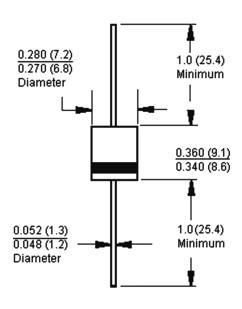




Note: 1. Rise Time = 7ns Maxitmum. Input Impedance =  $1M\Omega$  22pf

**Note: 2**. Rise Time = 10ns Maximum Source Impedance =  $50\Omega$ 

#### **DO-201AD**



Dimensions: Inches (Millimetres)

### **Part Number Table**

Description	Part Number		
Diode, Fast, 6A, 200V	HER603G		
Diode, Fast, 6A, 600V	HER606G		

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